



#### 65V P-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
-65V	8Ω @ V <sub>GS</sub> = -5V	-290mA
	18Ω @ V <sub>GS</sub> = -2.5V	-195mA

### **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

# Features and Benefits

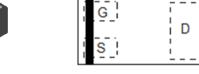
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (Approximate)

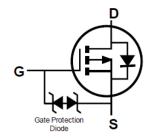






Top View

Pin-Out



**Bottom View** 

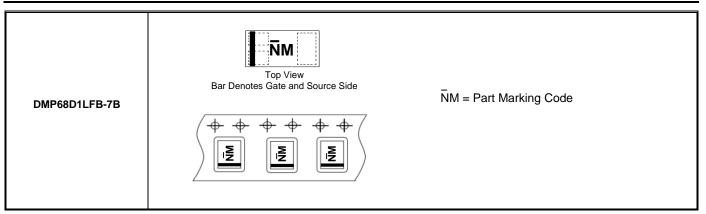
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP68D1LFB-7B	X1-DFN1006-3	10,000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**





### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characte	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	-65	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5) VGS = -5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-215 -170	mA
Continuous Drain Current (Note 6) VGS = -5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-290 -230	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			IDM	-800	mA
Maximum Body Diode Continuous Current (Note 6)			Is	-290	mA

# **Thermal Characteristics**

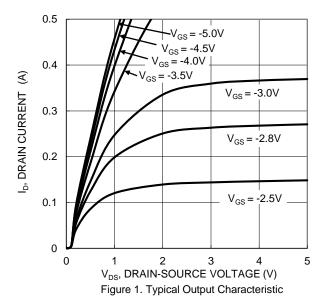
Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	0.7	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	Reja	180	°C/W
Power Dissipation (Note 6)	P <sub>D</sub>	1.2	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	Reja	100	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-65		_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	1	-1.0	μΑ	$V_{DS} = -65V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	-0.8	_	-2.1	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D	_	2.0	8	Ω	$V_{GS} = -5V, I_{D} = -100mA$	
Static Dialii-Source Off-Resistance	R <sub>DS(ON)</sub>	_	4.3	18	Ω	$V_{GS} = -2.5V, I_D = -20mA$	
Diode Forward Voltage	VsD	_	-0.8	-1.5	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = -100mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	42	_		V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	10	_	pF		
Reverse Transfer Capacitance	Crss	_	6	_		I = I.ONIAZ	
Gate Resistance	Rg	_	225	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	0.6	_		\\ \(\frac{1}{2}\)	
Gate-Source Charge	Qgs	_	0.1	_	nC	$V_{GS} = -5V, V_{DS} = -30V,$ $I_{D} = -100 \text{mA}$	
Gate-Drain Charge	$Q_{gd}$	_	0.2	_			
Turn-On Delay Time	t <sub>D</sub> (ON)	_	11	_		V <sub>GS</sub> = -5V, V <sub>DS</sub> = -30V,	
Turn-On Rise Time	t <sub>R</sub>	_	16	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	30	_	115	$R_G = 50\Omega$ , $I_D = -100$ mA	
Turn-Off Fall Time	tF	_	30	_			

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
  Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.





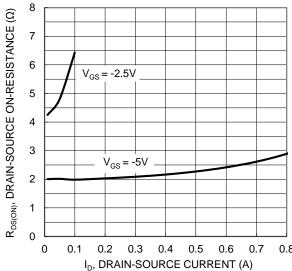


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

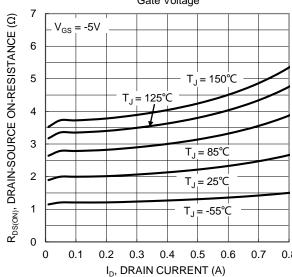


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

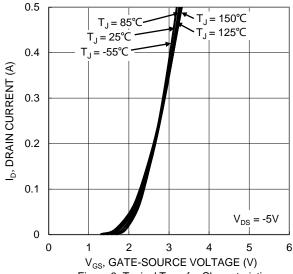
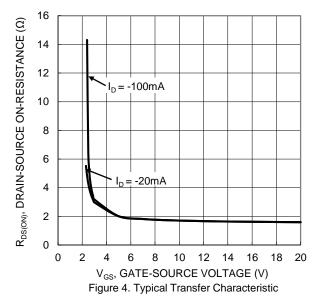


Figure 2. Typical Transfer Characteristic



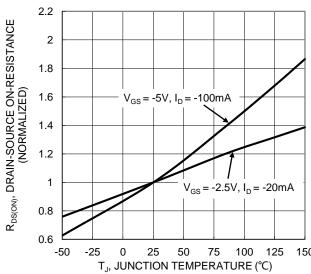
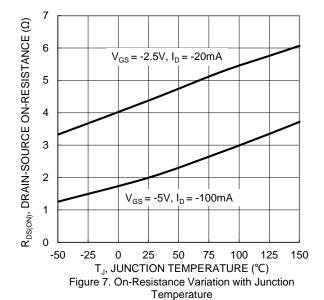
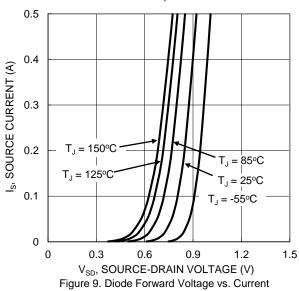
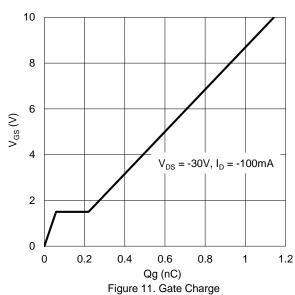


Figure 6. On-Resistance Variation with Junction Temperature









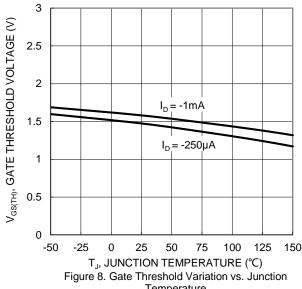
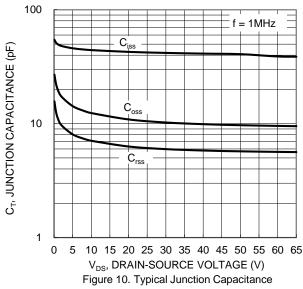
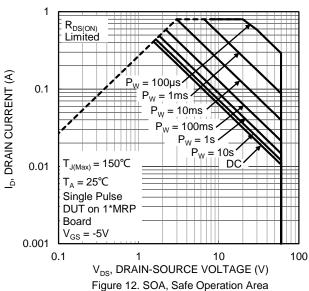


Figure 8. Gate Threshold Variation vs. Junction Temperature







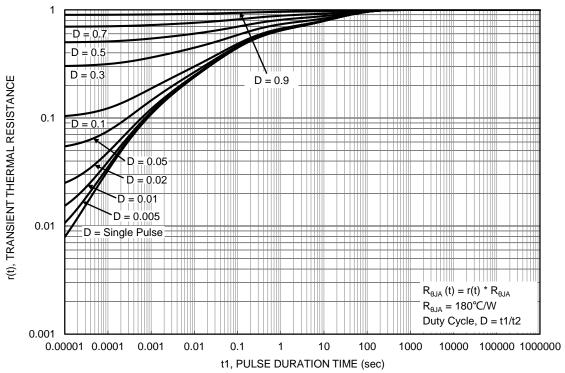


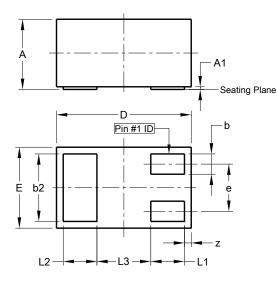
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-3

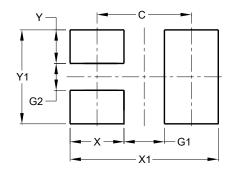


X1-DFN1006-3				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0.00	0.05	0.03	
b	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	-	-	0.40	
Z	0.02	0.08	0.05	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-3



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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